

DATASHEET

5 PIN SOP HIGH SPEED 1Mbit/s TRANSISTOR PHOTOCOUPLER ELM453H-G Series

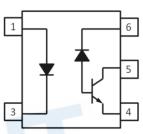
Preliminary



Features

- Compliance Halogen Free.
 (Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)
- Compliance with EU REACH
- Pb free and RoHS compliant.
- Guaranteed performance from -40 to 125°C
- High isolation voltage between input and output (Viso=3750 V rms)
- UL and cUL approved(No. E214129)
- VDE approved (No. 40028116)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved

Schematic



Pin Configuration

- 1: Anode
- 3: Cathode
- 4: GND
- 5: Vout
- 6: Vcc

Description

The ELM453H devices each consist of an infrared emitting diode, optically coupled to a high speed photo detector transistor. A separate connection for the photodiode bias and output-transistor collector increase the speed by several orders of magnitude over conventional phototransistor couplers by reducing the base-collector capacitance of the input transistor. The devices are packaged in industry standard 5pin SOP packages and are suitable for surface mounting.

Applications

- Line receivers
- Field bus communication and control.
- Power transistor isolation in motor drives
- Replacement for low speed phototransistor photo couplers
- High speed logic ground isolation
- Analog signal ground isolation



Absolute Maximum Ratings (T_A=25 °C)

	Parameter	Symbol	Rating	Unit
	Forward current	I _F	25	mA
Input	Reverse voltage	V_{R}	5	V
	Power dissipation	P_{D}	45	mW
	Power dissipation	Pc	85	mW
0 (- 1	Output current	Io	8	mA
Output	Output voltage	Vo	20	V
	Supply voltage	V _{CC}	30	V
Output Power Dissipation		Po	85	mW
Isolation Volta	ge*1	V _{ISO}	3750	Vrms
Operating Tem	perature	T _{OPR}	-40 ~ +125	°C
Storage Temp	erature	T _{STG}	-55 ~ +125	°C
Soldering Temperature*2		T _{SOL}	260	°C

Notes:

^{*1} AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1 & 3 are shorted together, and pins 4, 5 & 6 are shorted together.

^{*2} For 10 seconds



Electrical Characteristics

Input

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	V _F	-	1.4	1.8	V	I _F = 16mA
Reverse Current	I _R	-	-	10	μΑ	V _R = 5V
Input capacitance	Cin	-	70	-	pF	V _F =0, f=1MHz

Output

Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
High Level Output	I	-	0.05	5	μΑ	I_F =0mA, V_O = V_{CC} =15V, T_A =25°C
Current	Іон	-	-	50		$I_F=0$ mA, $V_O=V_{CC}=15$ V, $T_A=70$ °C
High level supply current	Іссн	-	0.5	2	uA	I _F =0mA, V _{CC} =15V

Transfer Characteristics

Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
Low Level Output Current	V _{OL}			0.4	V	I _F =16mA ,I _O =3mA, V _{CC} =4.5V
Current Transfer Ratio	CTR	20	-	-	%	I _F =16mA ,V _O =0.4V, V _{CC} =4.5V

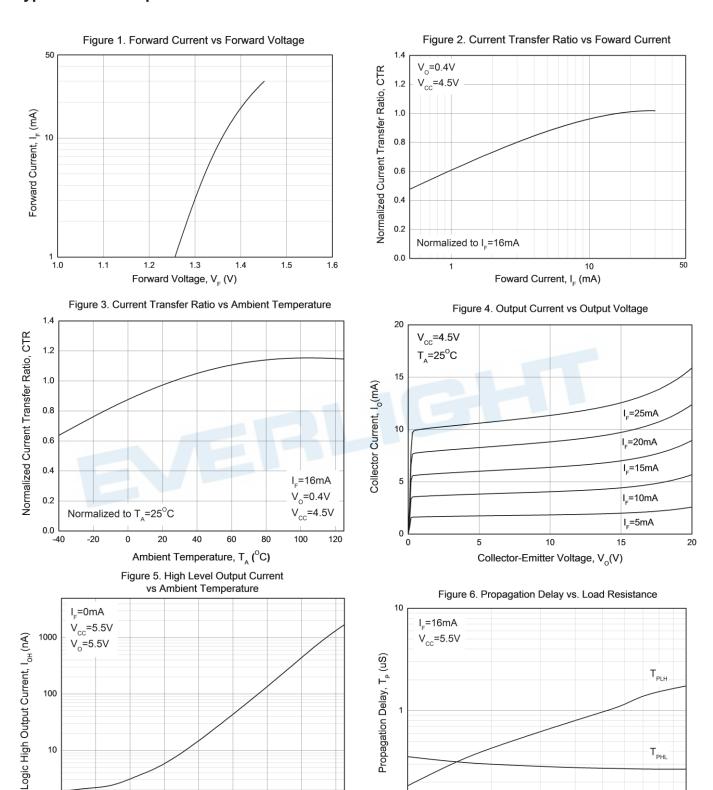
Switching Characteristics (TA=0 to 70°C unless specified otherwise)

Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
Propagation Delay Time to Logic Low	T_{PHL}	-	0.35	1.0	μs	$I_F=16mA, R_L=1.9K\Omega$
Propagation Delay Time to Logic High	T_PLH	-	0.45	1.0	μs	$I_F=16mA, R_L=1.9K\Omega$
Common Mode Transient Immunity at Logic High*3	СМн	10			KV/μS	$I_F = 0 \text{mA}$, $V_{\text{CM}} = 1500 \text{Vp-p}$, $R_L = 1.9 \text{K}\Omega$, $T_A = 25 ^{\circ}\text{C}$
Common Mode Transient Immunity at Logic Low*3	CML	10			KV/μS	I_F =16mA , V_{CM} =1500Vp-p, R_L =1.9K Ω , T_A =25°C

^{*}All typical at $T_A = 25$ °C



Typical Electro-Optical Characteristics Curves



-40

-20

Load Resistance, R_ι(KΩ)

10

100

Ambient Temperature, T_A (°C)

120

0.1

Figure 7. Propagation Delay vs. Temperature 1.0 I_=16mA 0.9 V_{cc}=5V Propagation Delay, T_p (uS) 0.8 0.7 0.6 0.5 0.3 0.2 0.1 -40 120 Ambient Temperature, T_A (°C)

Fig. 8 Switching Time Test circuit

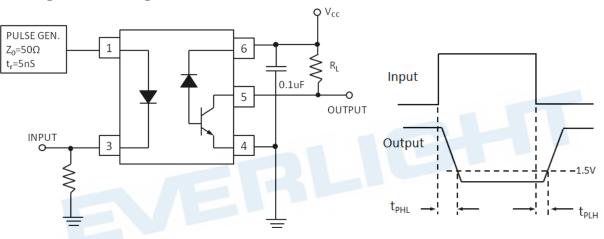
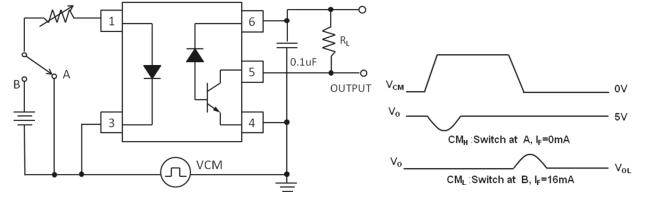


Fig. 9 Transient Immunity Test circuit



Note:

*3 Common mode transient immunity in logic high level is the maximum tolerable (positive) dVcm/dt on the leading edge of the common mode pulse signal VCM, to assure that the output will remain in a logic high state (i.e., $V_0 > 2.0V$).

Common mode transient immunity in logic low level is the maximum tolerable (negative) dVcm/dt on the trailing edge of the common mode pulse signal, VCM, to assure that the output will remain in a logic low state (i.e., $V_0 < 0.8V$)



Order Information

Part Number

ELM453H(Z)-VG

Note

Z = Tape and reel option (TA, TB or none)

V = VDE (optional) G = Halogens free

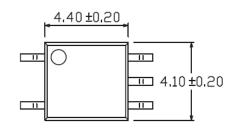
Option	Description	Packing quantity
None	Standard SMD option	100 units per tube
(TA)	Surface mount lead form + TA tape & reel option	3000 units per reel
(TB)	Surface mount lead form + TB tape & reel option	3000 units per reel

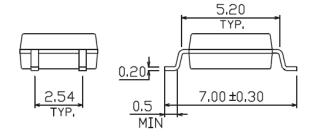


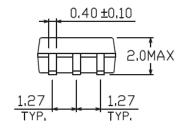


Package Dimension

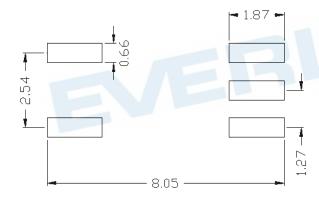
(Dimensions in mm)







Recommended pad layout for surface mount leadform



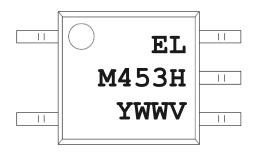
Notes

Suggested pad dimension is just for reference only.

Please modify the pad dimension based on individual need.



Device Marking



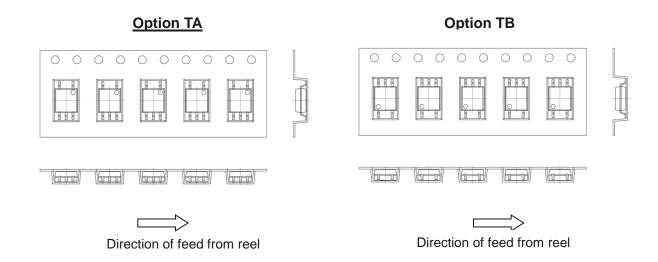
Notes

EL denotes EVERLIGHT
M453H denotes Device Number
Y denotes 1 digit Year code
WW denotes 2 digit Week code
V denotes VDE (optional)

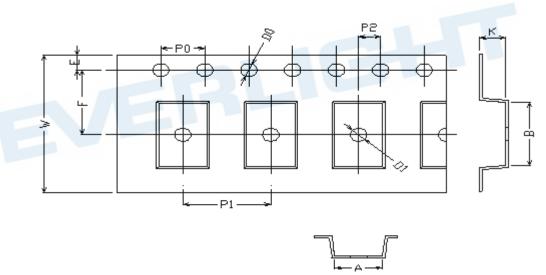




Tape & Reel Packing Specifications



Tape dimensions



Dimension No.	Α	В	Do	D1	E	F
Dimension (mm)	4.4 ± 0.1	7.4 ± 0.1	1.5 ± 0.1	1.5 ± 0.1	1.75± 0.1	7.5 ± 0.1
Dimension No.	Ро	P1	P2	t	W	К
Birneriolori No.	10				•••	1

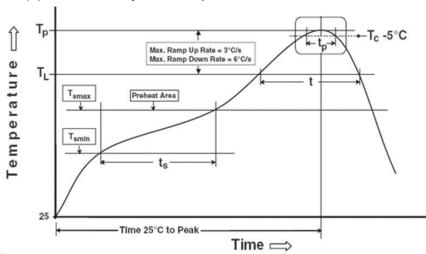


Reference: IPC/JEDEC J-STD-020D

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Preheat

Temperature min (T_{smin}) 150 °C Temperature max (T_{smax}) 200°C

Time (T_{smin} to T_{smax}) (t_s) 60-120 seconds 3 °C/second max

Average ramp-up rate (T_{smax} to T_p)

Other

217 °C Liquidus Temperature (T_L)

Time above Liquidus Temperature (t L) 60-100 sec

Peak Temperature (T_P) 260°C Time within 5 °C of Actual Peak Temperature: TP - 5°C 30 s

Ramp- Down Rate from Peak Temperature 6°C /second max.

Time 25°C to peak temperature 8 minutes max.

Reflow times 3 times



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